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Applications of "<u>Embedded - Microcontrollers</u>"

Details		
Product Status	Active	
Core Processor	eZ8	
Core Size	8-Bit	
Speed	5MHz	
Connectivity	IrDA, UART/USART	
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT	
Number of I/O	6	
Program Memory Size	4KB (4K x 8)	
Program Memory Type	FLASH	
EEPROM Size	-	
RAM Size	1K x 8	
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V	
Data Converters	A/D 4x10b	
Oscillator Type	Internal	
Operating Temperature	0°C ~ 70°C (TA)	
Mounting Type	Through Hole	
Package / Case	8-DIP (0.300", 7.62mm)	
Supplier Device Package	-	
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0423pb005sg	

Z8 Encore! XP[®] F0823 Series Product Specification



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Address Space

The eZ8 CPU can access three distinct address spaces:

- The Register File contains addresses for the general-purpose registers and the eZ8 CPU, peripheral, and general-purpose I/O Port Control Registers
- The Program Memory contains addresses for all memory locations having executable code and/or data
- The Data Memory contains addresses for all memory locations that contain data only

These three address spaces are covered briefly in the following subsections. For more detailed information regarding the eZ8 CPU and its address space, refer to the eZ8 CPU Core User Manual (UM0128), available for download at www.zilog.com.

Register File

The Register File address space in the Z8 Encore! XPTM MCU is 4KB (4096 bytes). The Register File is composed of two sections: control registers and general-purpose registers. When instructions are executed, registers defined as sources are read, and registers defined as destinations are written. The architecture of the eZ8 CPU allows all general-purpose registers to function as accumulators, address pointers, index registers, stack areas, or scratch pad memory.

The upper 256 bytes of the 4KB Register File address space are reserved for control of the eZ8 CPU, the on-chip peripherals, and the I/O ports. These registers are located at addresses from F00H to FFFH. Some of the addresses within the 256 B control register section are reserved (unavailable). Reading from a reserved Register File address returns an undefined value. Writing to reserved Register File addresses is not recommended and can produce unpredictable results.

The on-chip RAM always begins at address <code>000H</code> in the Register File address space. Z8 Encore! XP F0823 Series devices contain 256B–1KB of on-chip RAM. Reading from Register File addresses outside the available RAM addresses (and not within the control register address space) returns an undefined value. Writing to these Register File addresses produces no effect.

Program Memory

The eZ8 CPU supports 64KB of Program Memory address space. F0823 Series devices contain 1KB to 8KB of on-chip Flash memory in the Program Memory address space. Reading from Program Memory addresses outside the available Flash memory addresses

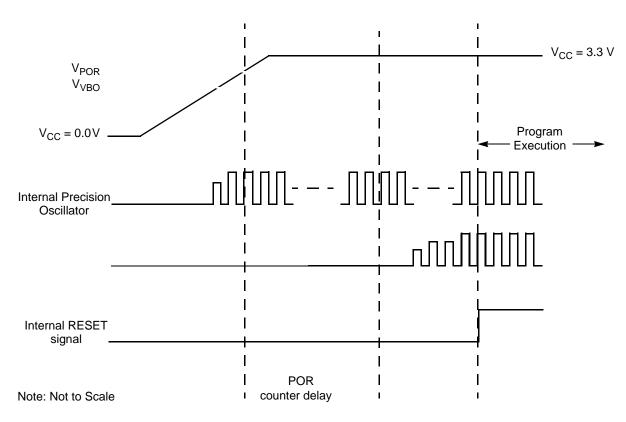


Figure 5. Power-On Reset Operation

Voltage Brown-Out Reset

The devices in the Z8 Encore! XP F0823 Series provide low VBO protection. The VBO circuit senses when the supply voltage drops to an unsafe level (below the VBO threshold voltage) and forces the device into the Reset state. While the supply voltage remains below the POR voltage threshold (V_{POR}) , the VBO block holds the device in the Reset.

After the supply voltage again exceeds the Power-On Reset voltage threshold, the device progresses through a full System Reset sequence, as described in the <u>Power-On Reset</u> section on page 23. Following POR, the POR status bit in the Reset Status (RSTSTAT) Register is set to 1. Figure 6 displays Voltage Brown-Out operation. For the VBO and POR threshold voltages (V_{VBO} and V_{POR}), see the <u>Electrical Characteristics</u> chapter on page 196.

The VBO circuit can be either enabled or disabled during STOP Mode. Operation during STOP Mode is set by the VBO_AO Flash Option bit. For information about configuring VBO AO, see the Flash Option Bits chapter on page 146.

Table 35. Trap and Interrupt Vectors in Order of Priority

Priority	Program Memory Vector Address	Interrupt or Trap Source
Highest	0002H	Reset (not an interrupt)
	0004H	Watchdog Timer (see the Watchdog Timer section on page 91)
	003AH	Primary Oscillator Fail Trap (not an interrupt)
	003CH	Watchdog Timer Oscillator Fail Trap (not an interrupt)
	0006H	Illegal Instruction Trap (not an interrupt)
	0008H	Reserved
	000AH	Timer 1
	000CH	Timer 0
	000EH	UART 0 receiver
	0010H	UART 0 transmitter
	0012H	Reserved
	0014H	Reserved
	0016H	ADC
	0018H	Port A Pin 7, selectable rising or falling input edge
	001AH	Port A Pin 6, selectable rising or falling input edge or Comparator Output
	001CH	Port A Pin 5, selectable rising or falling input edge
	001EH	Port A Pin 4, selectable rising or falling input edge
	0020H	Port A Pin 3 or Port D Pin 3, selectable rising or falling input edge
	0022H	Port A Pin 2 or Port D Pin 2, selectable rising or falling input edge
	0024H	Port A Pin 1, selectable rising or falling input edge
	0026H	Port A Pin 0, selectable rising or falling input edge
	0028H	Reserved
	002AH	Reserved
	002CH	Reserved
	002EH	Reserved
	0030H	Port C Pin 3, both input edges
	0032H	Port C Pin 2, both input edges
	0034H	Port C Pin 1, both input edges
	0036H	Port C Pin 0, both input edges
owest	0038H	Reserved

Interrupt Request 2 Register

The Interrupt Request 2 (IRQ2) register (Table 38) stores interrupt requests for both vectored and polled interrupts. When a request is presented to the interrupt controller, the corresponding bit in the IRQ2 Register becomes 1. If interrupts are globally enabled (vectored interrupts), the interrupt controller passes an interrupt request to the eZ8 CPU. If interrupts are globally disabled (polled interrupts), the eZ8 CPU can read the Interrupt Request 2 Register to determine if any interrupt requests are pending.

Table 38. Interrupt Request 2 Register (IRQ2)

Bit	7	6	5	4	3	2	1	0
Field	Reserved				PC3I	PC2I	PC1I	PC0I
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address		FC6H						

Bit	Description	
[7:4]	Reserved	
	These bits are reserved and must be programmed to 0000.	
[3:0]	Port C Pin x Interrupt Request	
PCxI	0 = No interrupt request is pending for GPIO Port C pin x.	
	1 = An interrupt request from GPIO Port C pin x is awaiting service.	
Note:	x indicates the specific GPIO Port C pin number (3–0).	

IRQ0 Enable High and Low Bit Registers

Table 39 describes the priority control for IRQ0. The IRQ0 Enable High and Low Bit registers (Table 40 and Table 41) form a priority-encoded enabling for interrupts in the Interrupt Request 0 Register. Priority is generated by setting bits in each register.

Table 39. IRQ0 Enable and Priority Encoding

IRQ0ENL[x]	Priority	Description
0	Disabled	Disabled
1	Level 1	Low
0	Level 2	Nominal
1	Level 3	High
	0 1 0 1	0 Disabled 1 Level 1 0 Level 2

Note: where *x* indicates the register bits from 0–7.

PWM Period (s) =
$$\frac{\text{Reload Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

If an initial starting value other than 0001H is loaded into the Timer High and Low Byte registers, use the ONE-SHOT Mode equation to determine the first PWM time-out period. If TPOL is set to 0, the ratio of the PWM output High time to the total period is represented by the following equation:

PWM Output High Time Ratio (%) =
$$\frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$$

If TPOL is set to 1, the ratio of the PWM output High time to the total period is represented by the following equation:

PWM Output High Time Ratio (%) =
$$\frac{PWM \text{ Value}}{\text{Reload Value}} \times 100$$

PWM Dual Output Mode

In PWM DUAL OUTPUT Mode, the timer outputs a PWM output signal pair (basic PWM signal and its complement) through two GPIO port pins. The timer input is the system clock. The timer first counts up to the 16-bit PWM match value stored in the Timer PWM High and Low Byte registers. When the timer count value matches the PWM value, the Timer Output toggles. The timer continues counting until it reaches the reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes.

If the TPOL bit in the Timer Control Register is set to 1, the Timer Output signal begins as a High (1) and transitions to a Low (0) when the timer value matches the PWM value. The Timer Output signal returns to a High (1) after the timer reaches the reload value and is reset to 0001H.

If the TPOL bit in the Timer Control Register is set to 0, the Timer Output signal begins as a Low (0) and transitions to a High (1) when the timer value matches the PWM value. The Timer Output signal returns to a Low (0) after the timer reaches the reload value and is reset to 0001H.

The timer also generates a second PWM output signal Timer Output Complement. The Timer Output Complement is the complement of the Timer Output PWM signal. A programmable deadband delay can be configured to time delay (0 to 128 system clock cycles) PWM output transitions on these two pins from a low to a high (inactive to active). This ensures a time gap between the deassertion of one PWM output to the assertion of its complement.

Observe the following steps to configure a timer for PWM DUAL OUTPUT Mode and initiating the PWM operation:

- 1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for PWM DUAL OUTPUT Mode. Setting the mode also involves writing to the TMODEHI bit in the TxCTL1 Register
 - Set the prescale value
 - Set the initial logic level (High or Low) and PWM High/Low transition for the Timer Output alternate function
- 2. Write to the Timer High and Low Byte registers to set the starting count value (typically 0001H); this write only affects the first pass in PWM Mode. After the first timer reset in PWM Mode, counting always begins at the reset value of 0001H.
- 3. Write to the PWM High and Low Byte registers to set the PWM value.
- 4. Write to the PWM Control Register to set the PWM dead band delay value. The dead-band delay must be less than the duration of the positive phase of the PWM signal (as defined by the PWM high and low byte registers). It must also be less than the duration of the negative phase of the PWM signal (as defined by the difference between the PWM registers and the Timer Reload registers).
- 5. Write to the Timer Reload High and Low Byte registers to set the reload value (PWM period). The reload value must be greater than the PWM value.
- 6. If appropriate, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.
- 7. Configure the associated GPIO port pin for the Timer Output and Timer Output Complement alternate functions. The Timer Output Complement function is shared with the Timer Input function for both timers. Setting the timer mode to Dual PWM automatically switches the function from Timer In to Timer Out Complement.
- 8. Write to the Timer Control Register to enable the timer and initiate counting.

The PWM period is represented by the following equation:

PWM Period (s) =
$$\frac{\text{Reload Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

If an initial starting value other than 0001H is loaded into the Timer High and Low Byte registers, the ONE-SHOT Mode equation determines the first PWM time-out period.

If TPOL is set to 0, the ratio of the PWM output High time to the total period is represented by:

Bit	Description (Continued)
[6] TPOL (cont'd.)	COMPARATOR COUNTER Mode When the timer is disabled, the Timer Output signal is set to the value of this bit. When the timer is enabled, the Timer Output signal is complemented upon timer reload.
	Caution: When the Timer Output alternate function TxOUT on a GPIO port pin is enabled, TxOUT changes to whatever state the TPOL bit is in. The timer does not need to be enabled for that to happen. Also, the port data direction sub register is not needed to be set to output on TxOUT. Changing the TPOL bit with the timer enabled and running does not immediately change the TxOUT.
[5:3] PRES	Prescale Value The timer input clock is divided by 2 ^{PRES} , where PRES can be set from 0 to 7. The prescaler is reset each time the timer is disabled. This reset ensures proper clock division each time the timer is restarted. 000 = Divide by 1. 001 = Divide by 2. 010 = Divide by 4. 011 = Divide by 8. 100 = Divide by 16. 101 = Divide by 32. 110 = Divide by 64. 111 = Divide by 128.
[2:0] TMODE	Timer Mode This field, along with the TMODEHI bit in TxCTL0 Register, determines the operating mode of the timer. TMODEHI is the most significant bit of the timer mode selection value. 0000 = ONE-SHOT Mode. 0001 = CONTINUOUS Mode. 0010 = COUNTER Mode. 0011 = PWM SINGLE OUTPUT Mode. 0100 = CAPTURE Mode. 0101 = COMPARE Mode. 0110 = GATED Mode. 0111 = CAPTURE/COMPARE Mode. 1000 = PWM DUAL OUTPUT Mode. 1001 = CAPTURE RESTART Mode. 1010 = COMPARATOR COUNTER Mode.



- Set or clear the CTSE bit to enable or disable control from the remote receiver using the CTS pin
- 6. Check the TDRE bit in the UART Status 0 Register to determine if the Transmit Data Register is empty (indicated by a 1). If empty, continue to Step 7. If the Transmit Data Register is full (indicated by a 0), continue to monitor the TDRE bit until the Transmit Data Register becomes available to receive new data.
- 7. Write the UART Control 1 Register to select the outgoing address bit.
- 8. Set the Multiprocessor Bit Transmitter (MPBT) if sending an address byte, clear it if sending a data byte.
- 9. Write the data byte to the UART Transmit Data Register. The transmitter automatically transfers the data to the Transmit Shift register and transmits the data.
- 10. Make any changes to the Multiprocessor Bit Transmitter (MPBT) value, if appropriate and MULTIPROCESSOR Mode is enabled,.
- 11. To transmit additional bytes, return to <u>Step 5</u>.

Transmitting Data Using the Interrupt-Driven Method

The UART Transmitter interrupt indicates the availability of the Transmit Data Register to accept new data for transmission. Observe the following steps to configure the UART for interrupt-driven data transmission:

- 1. Write to the UART Baud Rate High and Low Byte registers to set the appropriate baud rate.
- 2. Enable the UART pin functions by configuring the associated GPIO port pins for alternate function operation.
- 3. Execute a DI instruction to disable interrupts.
- 4. Write to the Interrupt control registers to enable the UART Transmitter interrupt and set the acceptable priority.
- 5. Write to the UART Control 1 Register to enable MULTIPROCESSOR (9-bit) Mode functions, if MULTIPROCESSOR Mode is appropriate.
- 6. Set the MULTIPROCESSOR Mode Select (MPEN) to Enable MULTIPROCESSOR Mode.
- 7. Write to the UART Control 0 Register to:
 - Set the transmit enable bit (TEN) to enable the UART for data transmission.
 - Enable parity, if appropriate and if MULTIPROCESSOR Mode is not enabled, and select either even or odd parity.

passed to the UART. Communication is half-duplex, which means simultaneous data transmission and reception is not allowed.

The baud rate is set by the UART's baud rate generator and supports IrDA standard baud rates from 9600 baud to 115.2 kbaud. Higher baud rates are possible, but do not meet IrDA specifications. The UART must be enabled to use the infrared endec. The infrared endec data rate is calculated using the following equation:

Infrared Data Rate (bits/s) =
$$\frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Baud Rate Divisor Value}}$$

Transmitting IrDA Data

The data to be transmitted using the infrared transceiver is first sent to the UART. The UART's transmit signal (TXD) and baud rate clock are used by the IrDA to generate the modulation signal (IR_TXD) that drives the infrared transceiver. Each UART/Infrared data bit is 16 clocks wide. If the data to be transmitted is 1, the IR_TXD signal remains low for the full 16 clock period. If the data to be transmitted is 0, the transmitter first outputs a 7 clock low period, followed by a 3 clock high pulse. Finally, a 6 clock low pulse is output to complete the full 16 clock data period. Figure 17 displays IrDA data transmission. When the infrared endec is enabled, the UART's TXD signal is internal to Z8 Encore! XP F0823 Series products while the IR_TXD signal is output through the TXD pin.

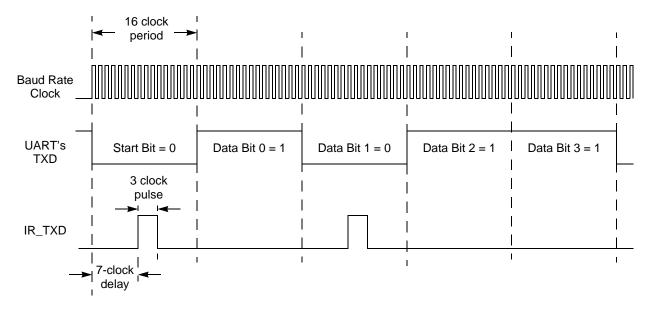


Figure 17. Infrared Data Transmission

Serialization Data

Table 96. Serial Number at 001C-001F (S_NUM)

Bit	7	6	5	4	3	2	1	0
Field				S_N	IUM			
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Information Page Memory 001C-001F							
Note: U =	e: U = Unchanged by Reset. R/W = Read/Write.							

Bit	Description
[7:0]	Serial Number Byte
S_NUM	The serial number is a unique four-byte binary value; see Table 97.

Table 97. Serialization Data Locations

Info Page Address	Memory Address	Usage
1C	FE1C	Serial Number Byte 3 (most significant).
1D	FE1D	Serial Number Byte 2.
1E	FE1E	Serial Number Byte 1.
1F	FE1F	Serial Number Byte 0 (least significant).

Randomized Lot Identifier

Table 98. Lot Identification Number (RAND_LOT)

Bit	7	6	5	4	3	2	1	0
Field				RAND	_LOT			
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Interspersed throughout Information Page Memory							
Note: U =	Note: U = Unchanged by Reset. R/W = Read/Write.							

Bit	Description
[7]	Randomized Lot ID
RAND_LOT	The randomized lot ID is a 32-byte binary value that changes for each production lot; see Table 99.



Table 99. Randomized Lot ID Locations

Info Page Address	Memory Address	Usage
3C	FE3C	Randomized Lot ID Byte 31 (most significant)
3D	FE3D	Randomized Lot ID Byte 30
3E	FE3E	Randomized Lot ID Byte 29
3F	FE3F	Randomized Lot ID Byte 28
58	FE58	Randomized Lot ID Byte 27
59	FE59	Randomized Lot ID Byte 26
5A	FE5A	Randomized Lot ID Byte 25
5B	FE5B	Randomized Lot ID Byte 24
5C	FE5C	Randomized Lot ID Byte 23
5D	FE5D	Randomized Lot ID Byte 22
5E	FE5E	Randomized Lot ID Byte 21
5F	FE5F	Randomized Lot ID Byte 20
61	FE61	Randomized Lot ID Byte 19
62	FE62	Randomized Lot ID Byte 18
64	FE64	Randomized Lot ID Byte 17
65	FE65	Randomized Lot ID Byte 16
67	FE67	Randomized Lot ID Byte 15
68	FE68	Randomized Lot ID Byte 14
6A	FE6A	Randomized Lot ID Byte 13
6B	FE6B	Randomized Lot ID Byte 12
6D	FE6D	Randomized Lot ID Byte 11
6E	FE6E	Randomized Lot ID Byte 10
70	FE70	Randomized Lot ID Byte 9
71	FE71	Randomized Lot ID Byte 8
73	FE73	Randomized Lot ID Byte 7
74	FE74	Randomized Lot ID Byte 6
76	FE76	Randomized Lot ID Byte 5
77	FE77	Randomized Lot ID Byte 4
79	FE79	Randomized Lot ID Byte 3
7A	FE7A	Randomized Lot ID Byte 2
7C	FE7C	Randomized Lot ID Byte 1
7D	FE7D	Randomized Lot ID Byte 0 (least significant)

On-Chip Debugger Commands

The host communicates to the OCD by sending OCD commands using the DBG interface. During normal operation, only a subset of the OCD commands are available. In DEBUG Mode, all OCD commands become available unless the user code and control registers are protected by programming the Flash Read Protect Option bit (FRP). The Flash Read Protect Option bit prevents the code in memory from being read out of Z8 Encore! XP F0823 Series products. When this option is enabled, several of the OCD commands are disabled.

Table 101 is a summary of the OCD commands. Each OCD command is described in further detail in the pages that follow this table. <u>Table 102</u> on page 167 also indicates those commands that operate when the device is not in DEBUG Mode (normal operation) and those commands that are disabled by programming the Flash Read Protect Option bit.

Table 101. OCD Commands

Debug Command	Command Byte	Enabled when not in DEBUG Mode?	Disabled by Flash Read Protect Option Bit
Read OCD Revision	00H	Yes	-
Reserved	01H	_	_
Read OCD Status Register	02H	Yes	_
Read Runtime Counter	03H	_	_
Write OCD Control Register	04H	Yes	Cannot clear DBGMODE bit.
Read OCD Control Register	05H	Yes	_
Write Program Counter	06H	_	Disabled.
Read Program Counter	07H	_	Disabled.
Write Register	08H	-	Only writes of the Flash Memory Control registers are allowed. Additionally, only the Mass Erase command is allowed to be written to the Flash Control Register.
Read Register	09H	_	Disabled.
Write Program Memory	0AH	-	Disabled.
Read Program Memory	0BH	_	Disabled.
Write Data Memory	0CH	_	Yes.
Read Data Memory	0DH	-	_
Read Program Memory CRC	0EH	_	_
Reserved	0FH	_	_
Step Instruction	10H	_	Disabled.
Stuff Instruction	11H		Disabled.
Execute Instruction	12H	_	Disabled.
Reserved	13H-FFH	_	_



Stuff Instruction (11H). The Stuff command steps one assembly instruction and allows specification of the first byte of the instruction. The remaining 0–4 bytes of the instruction are read from Program Memory. This command is useful for stepping over instructions where the first byte of the instruction has been overwritten by a Breakpoint. If the device is not in DEBUG Mode or the Flash Read Protect Option bit is enabled, the OCD ignores this command.

```
DBG ← 11H
DBG \leftarrow opcode[7:0]
```

Execute Instruction (12H). The Execute command allows sending an entire instruction to be executed to the eZ8 CPU. This command can also step over breakpoints. The number of bytes to send for the instruction depends on the opcode. If the device is not in DEBUG Mode or the Flash Read Protect Option bit is enabled, this command reads and discards one byte.

```
DBG ← 12H
DBG ← 1-5 byte opcode
```

On-Chip Debugger Control Register Definitions

This section describes the features of the On-Chip Debugger Control and Status registers.

OCD Control Register

The OCD Control Register controls the state of the OCD. This register is used to enter or exit DEBUG Mode and to enable the BRK instruction. It also resets Z8 Encore! XP F0823 Series device.

A reset and stop function can be achieved by writing 81H to this register. A reset and go function can be achieved by writing 41H to this register. If the device is in DEBUG Mode, a run function can be implemented by writing 40H to this register.

Table 118. eZ8 CPU Instruction Summary (Continued)

Assembly			ress ode	_ Opcode(s)			Fla	ags	_ Fetch	Instr.		
Mnemonic	Symbolic Operation	dst	src	(Hex)		Z	S	S V D H			Cycles	
LDX dst, src	dst ← src	r	ER	84	-	_	_	-	_	_	3	2
		Ir	ER	85							3	3
		R	IRR	86							3	4
		IR	IRR	87							3	5
		r	X(rr)	88	•						3	4
		X(rr)	r	89	•						3	4
		ER	r	94	•						3	2
		ER	lr	95	•						3	3
		IRR	R	96	•						3	4
		IRR	IR	97	•						3	5
		ER	ER	E8	•						4	2
		ER	IM	E9	•						4	2
LEA dst, X(src)	$dst \leftarrow src + X$	r	X(r)	98	_	_	_	-	_	-	3	3
		rr	X(rr)	99							3	5
MULT dst	dst[15:0] ← dst[15:8] * dst[7:0]	RR		F4	-	-	-	-	-	-	2	8
NOP	No operation			0F	_	_	_	-	_	-	1	2
OR dst, src	$dst \leftarrow dst \; OR \; src$	r	r	42	-	*	*	0	-	-	2	3
		r	lr	43							2	4
		R	R	44	_						3	3
		R	IR	45	_						3	4
		R	IM	46							3	3
		IR	IM	47							3	4
ORX dst, src	$dst \leftarrow dst \; OR \; src$	ER	ER	48	_	*	*	0	-	-	4	3
		ER	IM	49							4	3
POP dst	dst ← @SP	R		50	-	-	-	-	_	_	2	2
	SP ← SP + 1	IR		51							2	3

Note: Flags Notation:

^{* =} Value is a function of the result of the operation.

⁻ = Unaffected.

X = Undefined.

^{0 =} Reset to 0.

^{1 =} Set to 1.

Table 118. eZ8 CPU Instruction Summary (Continued)

Assembly			ress ode	_ Opcode(s)			Fla	ags			_ Fetch	Instr.
Mnemonic	Symbolic Operation	dst	src	(Hex)		Z	S	٧	D	Н	Cycles	
POPX dst	dst ← @SP SP ← SP + 1	ER		D8	_	-	_	-	-	-	3	2
PUSH src	SP ← SP – 1	R		70	-	-	-	-	-	-	2	2
	@SP ← src	IR		71	•						2	3
		IM		IF70							3	2
PUSHX src	SP ← SP − 1 @SP ← src	ER		C8	_	_	_	_	_	_	3	2
RCF	C ← 0			CF	0	_	_	_	_	_	1	2
RET	PC ← @SP SP ← SP + 2			AF	-	-	-	-	-	-	1	4
RL dst		R		90	*	*	*	*	_	_	2	2
	C	IR		91	-						2	3
RLC dst	<u> </u>	R		10	*	*	*	*	_	_	2	2
	C	IR		11	-						2	3
RR dst		R		E0	*	*	*	*	_	_	2	2
	D7 D6 D5 D4 D3 D2 D1 D0 C	IR		E1	-						2	3
RRC dst		R		C0	*	*	*	*	_	_	2	2
	D7 D6 D5 D4 D3 D2 D1 D0 C	IR		C1	•						2	3

Note: Flags Notation:

^{* =} Value is a function of the result of the operation.

⁻ = Unaffected.

X = Undefined.

^{0 =} Reset to 0.

^{1 =} Set to 1.

								Lo	ower Nil	bble (He	x)						
		0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F
	0	1.1 BRK	2.2 SRP IM	2.3 ADD r1,r2	2.4 ADD r1,lr2	3.3 ADD R2,R1	3.4 ADD IR2,R1	3.3 ADD R1,IM	3.4 ADD IR1,IM	4.3 ADDX ER2,ER1	4.3 ADDX IM,ER1	2.3 DJNZ r1,X	2.2 JR cc,X	2.2 LD r1,IM	3.2 JP cc,DA	1.2 INC r1	1.2 NOP
	1	2.2 RLC R1	2.3 RLC IR1	2.3 ADC r1,r2	2.4 ADC r1,lr2	3.3 ADC R2,R1	3.4 ADC IR2,R1	3.3 ADC R1,IM	3.4 ADC IR1,IM	4.3 ADCX ER2,ER1	4.3 ADCX IM,ER1						See 2nd Opcode Map
	2	2.2 INC R1	2.3 INC IR1	2.3 SUB r1,r2	2.4 SUB r1,lr2	3.3 SUB R2,R1	3.4 SUB IR2,R1	3.3 SUB R1,IM	3.4 SUB IR1,IM	4.3 SUBX ER2,ER1	4.3 SUBX IM,ER1						1
	3	2.2 DEC R1	2.3 DEC IR1	2.3 SBC r1,r2	2.4 SBC r1,lr2	3.3 SBC R2,R1	3.4 SBC IR2,R1	3.3 SBC R1,IM	3.4 SBC IR1,IM	4.3 SBCX ER2,ER1	4.3 SBCX IM,ER1						
	4	2.2 DA	2.3 DA	2.3 OR	2.4 OR	3.3 OR	3.4 OR	3.3 OR	3.4 OR	4.3 ORX	4.3 ORX						
	5	2.2 POP	2.3 POP	2.3 AND	2.4 AND	3.3 AND	3.4 AND	3.3 AND	3.4 AND	4.3 ANDX	4.3 ANDX						1.2 WDT
	6	2.2 COM	2.3 COM	2.3 TCM	2.4 TCM	3.3 TCM	3.4 TCM	3.3 TCM	3.4 TCM	4.3 TCMX	4.3 TCMX						1.2 STOP
Upper Nibble (Hex)	7	2.2 PUSH	2.3 PUSH	2.3 TM	r1,lr2 2.4 TM	3.3 TM	3.4 TM	3.3 TM	3.4 TM	4.3 TMX	4.3 TMX						1.2 HALT
er Nibb	8	2.5 DECW	2.6 DECW	2.5 LDE	r1,lr2 2.9 LDEI	3.2 LDX	3.3 LDX	3.4 LDX	3.5 LDX	3.4 LDX	3.4 LDX						1.2 DI
Opp	9	2.2 RL	2.3 RL	2.5 LDE	2.9 LDEI	3.2 LDX	3.3 LDX	3.4 LDX	3.5 LDX	3.3 LEA	3.5 LEA						1.2 El
	Α	2.5 INCW	2.6 INCW	2.3 CP	2.4 CP	3.3 CP	3.4 CP	3.3 CP	3.4 CP	r1,r2,X 4.3 CPX	4.3 CPX						1.4 RET
	В	2.2 CLR	2.3 CLR	r1,r2 2.3 XOR	r1,lr2 2.4 XOR	3.3 XOR	3.4 XOR	3.3 XOR	3.4 XOR	4.3 XORX	4.3 XORX						1.5 IRET
	С	2.2 RRC	2.3 RRC	r1,r2 2.5 LDC	r1,lr2 2.9 LDCI	2.3 JP	2.9 LDC	R1,IM	3.4 LD	3.2 PUSHX	IM,ER1						1.2 RCF
	D	2.2 SRA	2.3 SRA	2.5 LDC	2.9 LDCI	2.6 CALL	lr1,lrr2 2.2 BSWAP	3.3 CALL	r1,r2,X 3.4 LD	3.2 POPX							1.2 SCF
	E	2.2 RR	2.3 RR	r2,Irr1 2.2 BIT	2.3 LD	3.2 LD	R1 3.3 LD	3.2 LD	r2,r1,X 3.3 LD	4.2 LDX	4.2 LDX						1.2 CCF
	F	R1 2.2 SWAP	2.3 SWAP	p,b,r1 2.6 TRAP	r1,lr2 2.3 LD	R2,R1 2.8 MULT	3.3 LD	3.3 BTJ	3.4 BTJ	ER2,ER1	IM,ER1						
	٢	R1	IR1	Vector	Ir1,r2	RR1	R2,IR1		p,b,lr1,X			V	V	V	V	▼	

Figure 27. First Opcode Map

On-Chip Peripheral AC and DC Electrical Characteristics

Table 125 tabulates the electrical characteristics of the POR and VBO blocks.

Table 125. Power-On Reset and Voltage Brown-Out Electrical Characteristics and Timing

		$T_A = $	–40°C to +			
Symbol	Parameter	Minimum	Typical*	Maximum	Units	Conditions
V _{POR}	Power-On Reset Voltage Threshold	2.20	2.45	2.70	V	$V_{DD} = V_{POR}$
V_{VBO}	Voltage Brown-Out Reset Voltage Threshold	2.15	2.40	2.65	V	$V_{DD} = V_{VBO}$
	V _{POR} to V _{VBO} hysteresis		50	75	mV	
	Starting V _{DD} voltage to ensure valid Power-On Reset.	-	V _{SS}	_	V	
T _{ANA}	Power-On Reset Analog Delay	-	70	-	μs	V _{DD} > V _{POR} ; T _{POR} Digital Reset delay fol- lows T _{ANA}
T _{POR}	Power-On Reset Digital Delay		16		μs	66 Internal Precision Oscillator cycles + IPO startup time (T _{IPOST})
T _{SMR}	Stop Mode Recovery		16		μs	66 Internal Precision Oscillator cycles
T _{VBO}	Voltage Brown-Out Pulse Rejection Period	-	10	-	μs	Period of time in which V _{DD} < V _{VBO} without generating a Reset.
T _{RAMP}	Time for V_{DD} to transition from V_{SS} to V_{POR} to ensure valid Reset	0.10	-	100	ms	
T _{SMP}	Stop Mode Recovery pin pulse rejection period		20		ns	For any SMR pin or for the Reset pin when it is asserted in STOP Mode.

Note: *Data in the typical column is from characterization at 3.3 V and 30°C. These values are provided for design guidance only and are not tested in production.



Table 135. Z8 Encore! XP F0823 Series Ordering Matrix (Continued)

Part Number	Flash RAM	VO Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Description					
Z8 Encore! XP F0823	Series with 1	KB FI	ash									
Standard Temperature: 0°C to 70°C												
Z8F0113PB005SG	1 KB 256 B	6	12	2	0	1	PDIP 8-pin package					
Z8F0113QB005SG	1 KB 256 B	6	12	2	0	1	QFN 8-pin package					
Z8F0113SB005SG	1 KB 256 B	6	12	2	0	1	SOIC 8-pin package					
Z8F0113SH005SG	1 KB 256 B	16	18	2	0	1	SOIC 20-pin package					
Z8F0113HH005SG	1 KB 256 B	16	18	2	0	1	SSOP 20-pin package					
Z8F0113PH005SG	1 KB 256 B	16	18	2	0	1	PDIP 20-pin package					
Z8F0113SJ005SG	1 KB 256 B	24	18	2	0	1	SOIC 28-pin package					
Z8F0113HJ005SG	1 KB 256 B	24	18	2	0	1	SSOP 28-pin package					
Z8F0113PJ005SG	1 KB 256 B	24	18	2	0	1	PDIP 28-pin package					
Extended Temperatu	ure: -40°C to 1	05°C										
Z8F0113PB005EG	1 KB 256 B	6	12	2	0	1	PDIP 8-pin package					
Z8F0113QB005EG	1 KB 256 B	6	12	2	0	1	QFN 8-pin package					
Z8F0113SB005EG	1 KB 256 B	6	12	2	0	1	SOIC 8-pin package					
Z8F0113SH005EG	1 KB 256 B	16	18	2	0	1	SOIC 20-pin package					
Z8F0113HH005EG	1 KB 256 B	16	18	2	0	1	SSOP 20-pin package					
Z8F0113PH005EG	1 KB 256 B	16	18	2	0	1	PDIP 20-pin package					
Z8F0113SJ005EG	1 KB 256 B	24	18	2	0	1	SOIC 28-pin package					
Z8F0113HJ005EG	1 KB 256 B	24	18	2	0	1	SSOP 28-pin package					
Z8F0113PJ005EG	1 KB 256 B	24	18	2	0	1	PDIP 28-pin package					

Part Number Suffix Designations

Zilog part numbers consist of a number of components, as indicated in the following example.

Example. Part number Z8F0423SH005SG is an 8-bit 20MHz Flash MCU with 4KB of Program Memory and equipped with 6–22 I/O lines and 4–8 ADC channels in a 20-pin SOIC package, operating within a 0°C to +70°C temperature range and built using lead-free solder.

